

**VERTE.075C1****Serial No. 10/760,596****Supplemental Amendment****LISTING OF CLAIMS**

1. (Currently Amended) An assembly for cleaning a thin, flat substrate, the assembly comprising:

a support for engaging a thin, flat substrate, the substrate having at least a first surface;

a liquid engaging the first surface;

at least a first source of sonic energy; and

at least a first sonic energy transmitter spaced from the substrate but in contact with the liquid; wherein

the first source applies sonic energy to the transmitter, and the transmitter transmits the sonic energy to the substrate first surface ~~through the liquid~~, and the transmitter attenuates the sonic energy to reduce the number of sonic waves that strike the substrate at or near a ninety degree angle, wherein the transmitter includes one or more features selected from the group consisting of a substantially elliptical cross section, an elongate channel, elongate cutouts that create a narrow edge lying directly adjacent the substrate first surface, a roughened surface, and a plurality of bores.

2. (Previously Presented) The assembly of Claim 1, wherein the support engages a periphery of the substrate.

3. (Previously Presented) The assembly of Claim 1, wherein the support supports the substrate in a substantially horizontal orientation.

4. (Previously Presented) The assembly of Claim 1, wherein the support is rotatable.

5. (Previously Presented) The assembly of Claim 1, further comprising a first source of liquid, wherein the first source of liquid applies the liquid to the substrate first surface.

**VERTE.075C1****Serial No. 10/760,596****Supplemental Amendment**

6. (Previously Presented) The assembly of Claim 1, wherein the first source of liquid is a sprayer.
7. (Previously Presented) The assembly of Claim 1, wherein the first source of sonic energy comprises a transducer.
8. (Previously Presented) The assembly of Claim 7, wherein the transducer is coupled to the transmitter.
9. (Previously Presented) The assembly of Claim 1, wherein the first sonic energy transmitter comprises an elongate probe.
10. (Previously Presented) The assembly of Claim 9, wherein the probe extends generally parallel to the substrate first surface.
11. (Previously Presented) The assembly of Claim 9, wherein a portion of the probe directly adjacent to the substrate is configured to reduce a ratio of normal incident waves to shallow angle waves.
12. (Previously Presented) The assembly of Claim 9, wherein a portion of the probe directly adjacent the substrate first surface includes a substantially elliptical cross section.
13. (Previously Presented) The assembly of Claim 9, wherein a portion of the probe directly adjacent the substrate first surface includes an elongate channel.
14. (Previously Presented) The assembly of Claim 9, wherein a portion of the probe includes elongate cutouts that create a narrow edge of the probe, the edge lying directly adjacent the substrate first surface.
15. (Previously Presented) The assembly of Claim 9, wherein a portion of the probe directly adjacent the substrate first surface includes a roughened surface.
16. (Previously Presented) The assembly of Claim 9, wherein a portion of the probe directly adjacent the substrate first surface includes a plurality of bores.

**VERTE.075C1****Serial No. 10/760,596****Supplemental Amendment**

17. (Currently Amended) The apparatus of claim 1 wherein ~~An apparatus for cleaning a thin, flat substrate, the apparatus comprising:~~  
a the support supporting supports the substrate in a generally horizontal orientation;  
further including means for applying a thin film of liquid to a first surface of the substrate; ~~and a sonic energy transmitter; wherein~~  
~~the transmitter transmits sonic energy to the substrate first surface, and the transmitter attenuates the sonic energy to reduce the number of sonic waves that strike the substrate at or near a ninety degree angle.~~
18. (Previously Presented) The apparatus of Claim 17, wherein the transmitter transmits sonic energy to the substrate first surface through the liquid.
19. (Previously Presented) The apparatus of Claim 17, wherein the substrate first surface is a top surface.
20. (Previously Presented) The apparatus of Claim 17, wherein the substrate is a semiconductor wafer.
21. (Previously Presented) The assembly of Claim 17, wherein the support is rotatable.
22. (Previously Presented) The apparatus of Claim 17, wherein the means for applying a thin film of liquid comprises a sprayer.
23. (Previously Presented) The apparatus of Claim 17, wherein the sonic energy transmitter comprises an elongate probe.
24. (Previously Presented) The apparatus of Claim 17, wherein the transmitter is formed of quartz, sapphire, silicon carbide, silicon nitride, quartz coated with silicon carbide or quartz coated with vitreous carbon.

**VERTE.075C1****Serial No. 10/760,596****Supplemental Amendment**

25. (Previously Presented) The apparatus of Claim 17, further comprising a source of sonic energy coupled to the transmitter.

26. (Previously Presented) The apparatus of Claim 25, wherein the source of sonic energy is a transducer.

27. (Currently Amended) Apparatus for cleaning a thin article having at least a first substantially planar surface, the apparatus comprising:

a support for the article;

a source of fluid for applying fluid to the first surface;

a transmitter configured to vibrate so as to transmit sonic energy through the fluid to the first surface to loosen particles on the first surface;

a transducer for vibrating the transmitter; and

a wall with an opening therein through which gas is introduced to flow in contact with the transducer; wherein the transmitter includes one or more features selected from the group consisting of a substantially elliptical cross section, an elongate channel, elongate cutouts that create a narrow edge lying directly adjacent the substrate first surface, a roughened surface, and a plurality of bores; and

the transmitter attenuates the sonic energy to reduce the number of sonic waves that strike the article at or near a ninety degree angle.

28. (Previously Presented) The apparatus of Claim 27, wherein the article is supported in a substantially horizontal orientation.

29. (Previously Presented) The apparatus of Claim 27, wherein the article comprises a semiconductor wafer.

30. (Previously Presented) The apparatus of Claim 27, wherein the source of fluid comprises a sprayer.

**VERTE.075C1****Serial No. 10/760,596****Supplemental Amendment**

31. (Previously Presented) The apparatus of Claim 27, wherein the wall forms a part of an enclosure, and the enclosure creates a space surrounding the transducer, and the opening introduces gas into the space.

32. (Previously Presented) The apparatus of Claim 31, wherein the gas purges the space.

33. (Previously Presented) The apparatus of Claim 31, wherein the gas cools the transducer.

34. (Currently Amended )A method of cleaning a thin, flat substrate, the method comprising the steps of:

supporting a thin, flat substrate, the substrate having at least a first surface;

applying a liquid to the first surface;

providing at least a first source of sonic energy;

providing at least a first sonic energy transmitter spaced from the substrate but in contact with the liquid, the transmitter including one or more features selected from the group consisting of a substantially elliptical cross section, an elongate channel, elongate cutouts that create a narrow edge lying directly adjacent the substrate first surface, a roughened surface, and a plurality of bores;

energizing the first source of sonic energy, thereby applying sonic energy to the transmitter;

transmitting sonic energy through the transmitter to the substrate first surface through the liquid; and

attenuating the sonic energy to reduce the number of sonic waves that strike the substrate at or near a ninety degree angle.

**VERTE.075C1****Serial No. 10/760,596****Supplemental Amendment**

35. (Previously Presented) The method of Claim 34, further comprising the step of supporting the substrate in a substantially horizontal orientation.

36. (Previously Presented) The method of Claim 34, further comprising the step of rotating the substrate as the liquid and sonic energy are applied to the substrate first surface.

37. (Previously Presented) The method of Claim 34, further comprising the step of spraying the liquid onto the substrate first surface.

38. (Previously Presented) The method of Claim 34, further comprising the step of reducing a ratio of normal incident waves to shallow angle waves.